

ROHS

HALOGEN FREE

Hyperfast Rectifier, 60 A FRED Pt® G5



LINKS TO ADDITIONAL RESOURCES





PRIMARY CHARACTERISTICS						
I _{F(AV)}	60 A					
V _R	600 V					
V _F at I _F at 125 °C	1.2 V					
t _{rr} (typ.)	29 ns					
I _{FSM}	500 A					
T _J max.	175 °C					
Package	TO-247AD 3L					
Circuit configuration	Single					

FEATURES

- Hyperfast and optimized Q_{rr}
- Best in class forward voltage drop and switching losses trade off



- 175 °C maximum operating junction temperature
- Polyimide passivation
- AEC-Q101 qualified, meets JESD 201 whisker test 2
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV on-board battery chargers

MECHANICAL DATA

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating **Terminal:** matte tin plated leads, solderable per J-STD-002

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	V_{RRM}		600	V			
Average rectified forward current	I _{F(AV)}	T _C = 110 °C, D = 0.50	60				
Non-repetitive peak surge current	I _{FSM}	T _C = 25 °C, t _p = 10 ms, sine wave both anodes, (1) and (3) connected	500	Α			
Repetitive peak forward current	I _{FRM}	T _C = 110 °C, D = 0.50, f = 20 kHz	120				
Operating junction and storage temperature	T _J , T _{Stg}		-55 to +175	°C			

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	600	-	-	.,		
Forward voltage	V _F	I _F = 60 A	-	1.4	1.7	V		
		I _F = 60 A, T _J = 125 °C	-	1.2	-			
Reverse leakage current	I _R	$V_R = V_R$ rated	-	-	25			
neverse leakage current		$T_J = 125$ °C, $V_R = V_R$ rated	ı	1	500	μA		
Junction capacitance	C _T	V _R = 200 V	-	65	-	pF		
Series inductance	L _S	Measured to lead 5 mm from package body	-	8	-	nΗ		



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1 A$, $dI_F/dt = 1$	00 A/μs, V _R = 30 V	-	29	-		
Reverse recovery time	t _{rr}	T _J = 25 °C		-	49	-	ns	
		T _J = 125 °C		-	74	-		
Dook recovery ourrent	1	T _J = 25 °C	$I_F = 40 \text{ A}$	-	21	-	А	
Peak recovery current	I _{RRM}	T _J = 125 °C	dI _F /dt = 1000 A/μs - V _R = 400 V	-	43	-		
Poverse receivent charge	Q _{rr}	T _J = 25 °C		-	640	-	nC	
Reverse recovery charge		T _J = 125 °C		-	1979	-		
Reverse recovery time	t _{rr}	T _J = 25 °C	I _F = 60 A dI _F /dt = 1000 A/μs V _R = 400 V	-	54	-	ns	
neverse recovery time		T _J = 125 °C		-	82	-		
Dook recovery ourrent		T _J = 25 °C		-	22	-	А	
Peak recovery current	I _{RRM}	T _J = 125 °C		-	47	-		
Reverse recovery charge		T _J = 25 °C		-	790	-	nC	
	Q _{rr}	T _J = 125 °C		-	2385	-		

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction-to-case	R _{thJC}		-	-	0.63	°C/W	
Weight			-	5.5	-	g	
Mounting torque			1.2 (5.0)	-	24 (10)	kgf · cm (lbf · in)	
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C	
Marking device		Case style TO-247AD 3L	A5PH6006LH				

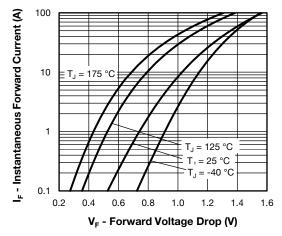


Fig. 1 - Typical Forward Voltage Drop Characteristics

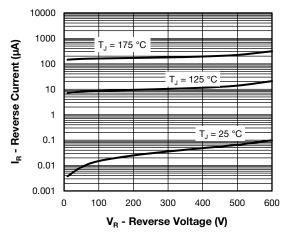


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

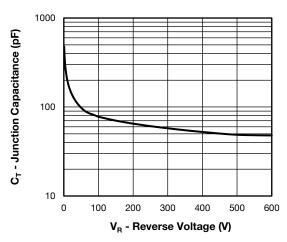


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

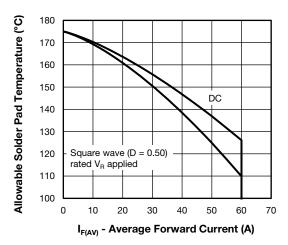


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

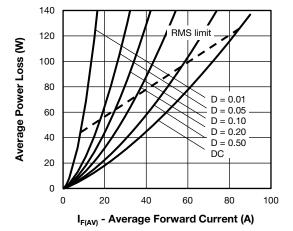


Fig. 5 - Average Power Loss vs. Average Forward Current

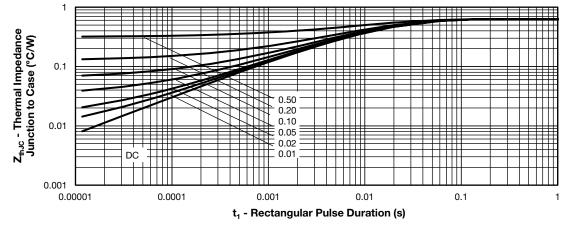


Fig. 6 - Thermal Impedance Z_{thJC} Characteristics

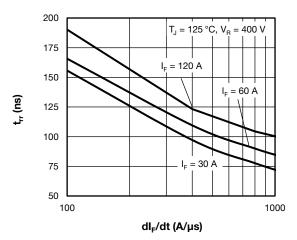


Fig. 7 - Typical Reverse Recovery Time vs. dI_E/dt

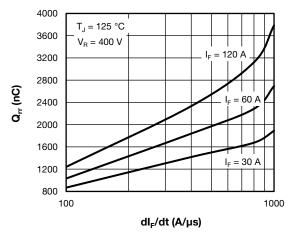


Fig. 8 - Typical Reverse Recovery Charge vs. dl_F/dt

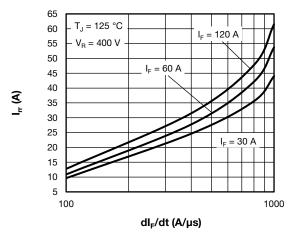


Fig. 9 - Typical Reverse Recovery Current vs. dl_F/dt

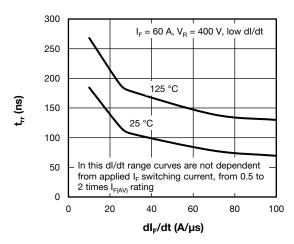


Fig. 10 - Typical Reverse Recovery Time vs. dl_F/dt

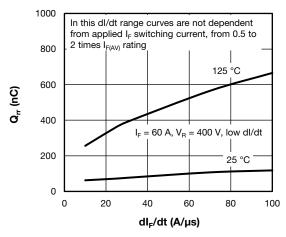


Fig. 11 - Typical Reverse Recovery Charge vs. dl_F/dt

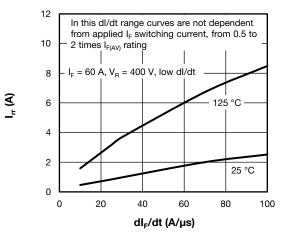


Fig. 12 - Typical Reverse Recovery Current vs. dl_F/dt

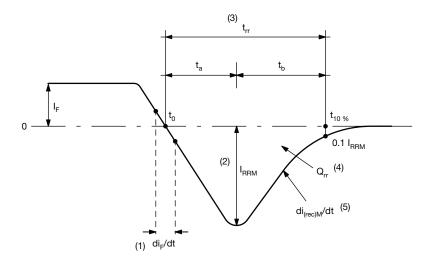


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

- $^{(1)}$ di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- $^{(3)}$ t_{rr} reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, 0.1 I_{RRM}
- $^{(4)}~Q_{rr}$ area under curve defined by t_0 and $t_{10~\%}$

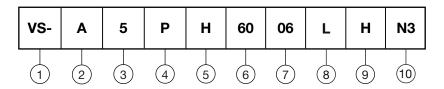
$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

 $^{(5)}$ di_(rec)M/dt - peak rate of change of current during t_b portion of t_{rr}



ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

- Circuit configuration

A = single diode, 2 anodes

3 - FRED Pt® Gen 5

4 - P = TO-247 package

5 - Process type:

H = hyperfast recovery

6 - Current rating 60 = 60 A)

7 - Voltage rating (06 = 600 V)

8 - Package: L = long lead (TO-247AD)

9 - H = AEC-Q101 qualified

- Environmental digit:

N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-A5PH6006LHN3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95626				
Part marking information	www.vishay.com/doc?95007				
SPICE model	www.vishay.com/doc?96957				



TO-247AD 3L

DIMENSIONS in millimeters and inches



View B

	MILLIMETERS INCHES					
SYMBOL	IVIILLIIV	IETEKS	INC	пЕЭ	NOTES	
01111202	MIN.	MAX.	MIN.	MAX.		
Α	4.65	5.31	0.183	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.50	2.49	0.059	0.098		
b	0.99	1.40	0.039	0.055		
b1	0.99	1.35	0.039	0.053		
b2	1.65	2.39	0.065	0.094		
b3	1.65	2.34	0.065	0.092		
b4	2.59	3.43	0.102	0.135		
b5	2.59	3.38	0.102	0.133		
С	0.38	0.89	0.015	0.035		
c1	0.38	0.84	0.015	0.033		
D	19.71	20.70	0.776	0.815	3	
D1	13.08	-	0.515	-	4	

Section C - C, D - D, E - E

SYMBOL	MILLIN	IETERS	INCHES		NOTES
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.2	0.254)10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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